

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	44090	(die or dye) near5 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:01
L2	33966	(die or dye) near3 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:01
L3	316	(adjust\$3) near15 (die or dye) near3 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:10
L4	118	3 and (location\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:11
L5	10	4 and (die or dye) near5 (plac\$5) with (wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:02
L6	1	(adjust\$3) near15 (dice) near3 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:10
L7	297	(adjust\$3) near5 (dice or dye or die) near15 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:10
L8	186	(adjust\$3) near3 (dice or dye or die) near15 (plac\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:12
L9	78	8 and (location\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:11

L10	9574	(adjust\$3) near3 (dice or dye or die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:13
L11	8	(adjust\$3) near3 (dice or dye or die) with (locations) with (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:14
L12	2466	(dice or dye or die) with (locations) with (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:14
L13	33	(dice or dye or die) near3 (placement) with (locations) with (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:21
L14	20735	(dice or dye or die) and (placement) and (locations) and (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:21
L15	330	14 and (adjust\$3) with (placement)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:30
L16	1504	14 and (die or dice1 or dye) with (placement)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:30
L17	292	14 and (die or dice1 or dye) with (placement) same (wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/28 13:31